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A Product Line of **Diodes Incorporated**

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Halogen and Antimony Free. "Green" Device (Note 1) Qualified to AEC-Q101 Standards for High Reliability

Case Material: Molded Plastic, "Green" Molding Compound.

Terminals: Finish - Matte Tin annealed over Copper leadframe.

UL Flammability Classification Rating 94V-0 (Note 1)

Moisture Sensitivity: Level 1 per J-STD-020

Terminal Connections: See Diagram Below

Solderable per MIL-STD-202, Method 208

Weight: 0.074 grams (approximate)

Features and Benefits

Lead Free/RoHS Compliant (Note 1)

Low On-Resistance Low Input Capacitance Fast Switching Speed Low Input/Output Leakage

Mechanical Data Case: SO-8

DMN2027USS

Product Summary

V _{(BR)DSS}	R _{DS(on)} max	I _D max T _A = 25°C (Note 3)
20V	$20m\Omega @ V_{GS}=4.5V$	9.8A
	28mΩ @ V _{GS} = 2.5V	8.3A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

SO-8

Top View

- Battery charging
- Power management functions
- **DC-DC** converters
- Portable power adaptors

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Equivalent Circuit

Ordering Information (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
DMN2027USS-13	N2027US	13	12	2,500

Notes: 1. No purposefully added lead. Diodes Inc.'s "Green" policy and packaging details can be found on our website at http://www.diodes.com

Marking Information



D11 = Manufacturer's Marking N2027US = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 10 = 2010)WW = Week (01 - 53)



Maximum Ratings $@T_A = 25^{\circ}C$ unless otherwise specified

Characteristic			Symbol	Value	Unit		
Drain-Source voltage			V _{DSS}	V			
Gate-Source voltage			V _{GS}	±12	V		
Continuous Drain current		(Note 3)	Ι _D	9.8			
	$V_{GS} = 4.5V$	$T_{A} = 70^{\circ}C$ (Note 3)		7.9			
		(Note 2)		7.3	А		
Pulsed Drain current	$V_{GS} = 4.5V$	(Note 4)	I _{DM}	45.0			
Continuous Source current (Body diode)		(Note 3)	I _S	6.0			
Pulsed Source current (Body diode) (No		(Note 4)	I _{SM}	45.0			

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit		
Power dissipation	(Note 2)		1.56 12.5	W	
Linear derating factor	(Note 3)	P _D	2.81 22.5	mW/°C	
Thermal Resistance, Junction to Ambient	(Note 2)		80.0		
memai Resistance, Junction to Ambient	(Note 3)	R _θ JA	44.5	°C/W	
Thermal Resistance, Junction to Lead	(Note 5)	R _{θJL}	37.0		
Operating and storage temperature range		TJ, TSTG	-55 to 150	°C	

Notes: 2. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

3. Same as note (2), except the device is measured at t \leq 10 sec.

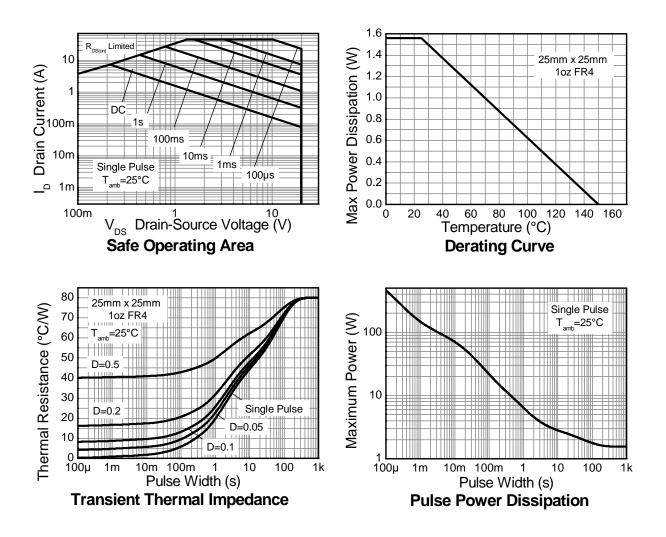
4. Same as note (2), except the device is pulsed with D = 0.02 and pulse width 300μ s.

5. Thermal resistance from junction to solder-point (at the end of the drain lead).





Thermal Characteristics





DMN2027USS

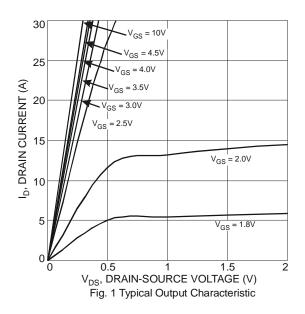
Electrical Characteristics @T_A = 25°C unless otherwise specified

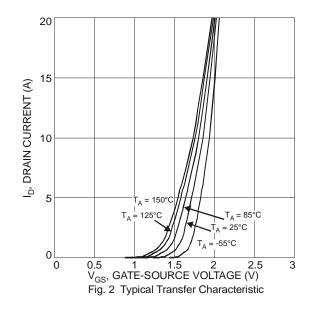
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS		_						
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current	IDSS	-	-	1.0	μΑ	$V_{DS} = 20V, V_{GS} = 0V$		
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$		
ON CHARACTERISTICS	·							
Gate Threshold Voltage	V _{GS(th)}	0.6	1.0	1.3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$		
Static Drain-Source On-Resistance (Note 6)			11	20	mΩ	$V_{GS} = 4.5V, I_D = 9.4A$		
Static Drain-Source On-Resistance (Note 6)	R _{DS (ON)}	-	15	28		V _{GS} = 2.5V, I _D = 8.3A		
Forward Transfer Admittance (Note 6 & 7)	Y _{fs}	-	16	-	S	$V_{DS} = 5V, I_{D} = 9.4A$		
Diode Forward Voltage (Note 6)	V _{SD}	-	0.7	1.3	V	$V_{GS} = 0V, I_{S} = 1.3A$		
DYNAMIC CHARACTERISTICS (Note 7)								
Input Capacitance	C _{iss}	-	1000	-		$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz		
Output Capacitance	Coss	-	166	-	pF			
Reverse Transfer Capacitance	C _{rss}	-	158	-		1 = 1.000112		
Gate Resistance	Rg	-	1.51	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		
Total Gate Charge (Note 8)	Qg	-	7.0	-		$V_{GS} = 2.5V$		
Total Gate Charge (Note 8)	Qq	-	11.6	-	-0	V _{DS} = 10V		
Gate-Source Charge (Note 8)	Q _{gs}	-	2.7	-	nC	$V_{GS} = 4.5V$ $I_D = 9.4A$		
Gate-Drain Charge (Note 8)	Q _{gd}	-	3.4	-				
Turn-On Delay Time (Note 8)	t _{D(on)}	-	11.67	-				
Turn-On Rise Time (Note 8)	tr	-	12.49	-		$V_{GS} = 4.5V, V_{DS} = 10V,$		
Turn-Off Delay Time (Note 8)	t _{D(off)}	-	35.89	-	ns	$R_G = 6\Omega$, $I_D = 1A$		
Turn-Off Fall Time (Note 8)	tf	-	12.33	-				

Notes:

6. Measured under pulsed conditions. Pulse width \leq 300 μ s; duty cycle \leq 2%

For design aid only, not subject to production testing.
Switching characteristics are independent of operating junction temperatures.

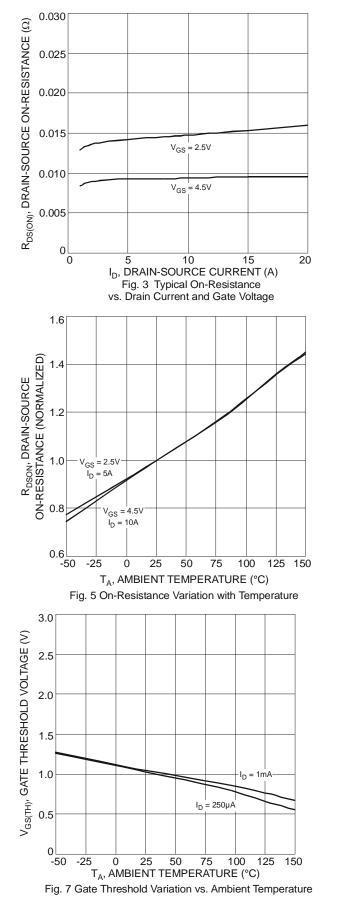


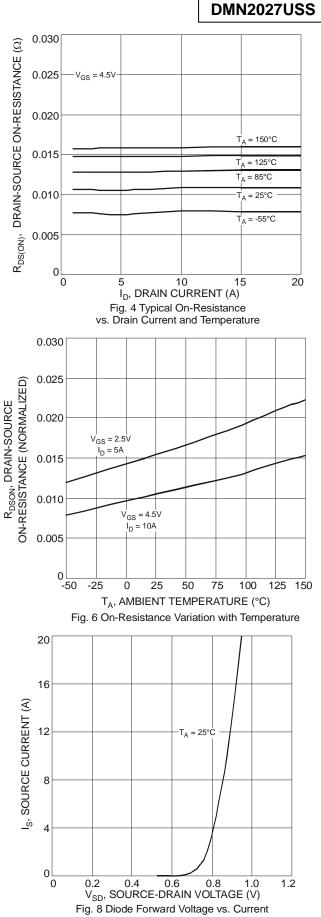




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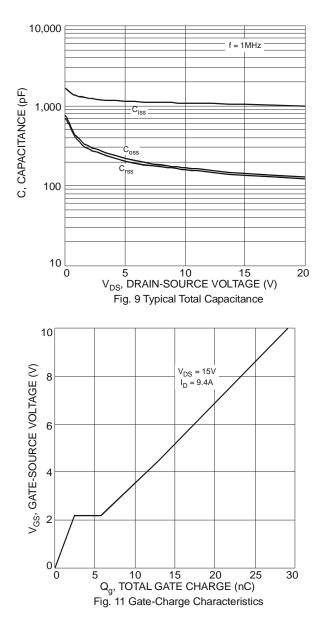
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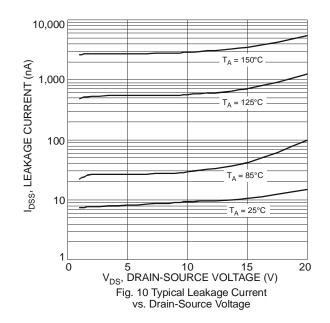


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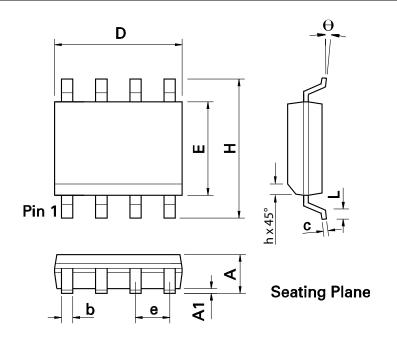






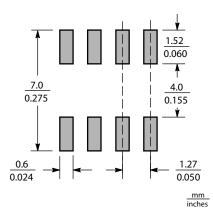


Package Outline Dimensions



DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
А	0.053	0.069	1.35	1.75	е	0.050 BSC		1.27 BSC	
A1	0.004	0.010	0.10	0.25	b	0.013	0.020	0.33	0.51
D	0.189	0.197	4.80	5.00	С	0.008	0.010	0.19	0.25
н	0.228	0.244	5.80	6.20	θ	0°	8°	0°	8°
E	0.150	0.157	3.80	4.00	h	0.010	0.020	0.25	0.50
L	0.016	0.050	0.40	1.27	-	-	-	-	-

Suggested Pad Layout



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